DATA SHEET

Part No.	AN5833SA		
Package Code No.	SSOP 024 - P - 0300E		

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AN5833SA

Silicon Monolithic Bipolar IC

■ Features

- Supports both I²C bus and parallel control
- Integrated SIF demodulation
- Fully adjustment free (when used with SIF input) 2 adjustment points when used with baseband input
- Integrated voice AGC circuit
- Reduced peripheral component count
- Low power consumption (typ. $V_{CC} = 5 \text{ V}$, $I_{TOT} = 28 \text{ mA}$)
- Near pin to pin compatible with AN5832SA (US TV audio multiplex demodulation IC)

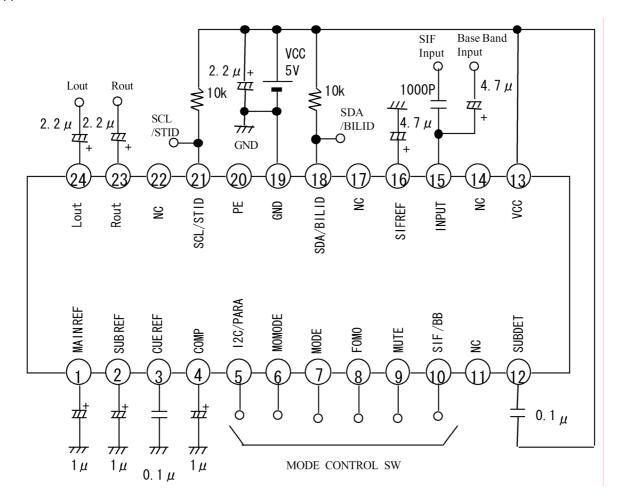
Applications

• TV sets, VCRs, DVD recorders, PCs, car navigation systems, and similar products for Japanese market

■ Package

• DIL-24PIN Plastic Package (SO Type)

■ Application Circuit

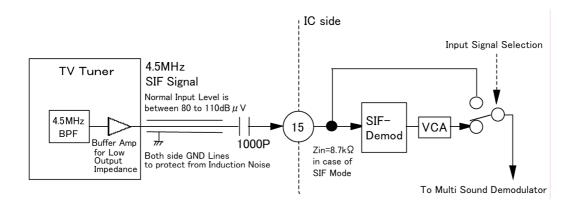


< Instructions of Application Circuits >

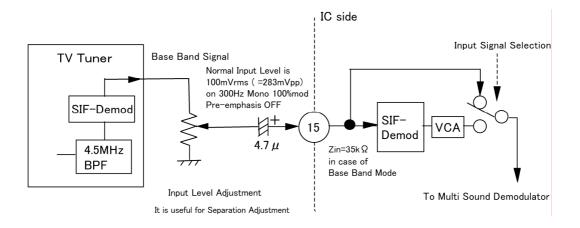
- In case of using base band input, ICs were adjusted to perform good separation when input level ismatched with 100 mV[rms] (= 283 mV[p-p]) on condition of mono 100% mod pre-emphasis OFF.
 However, if good enough separation can't be taken in the cause of un-matching frequency characteristic and so in input signal, it can adjust separation by the input volume.
- 2) In case of using SIF input, please set up the SIF input level from tuners between $80~dB\mu V$ to $110~dB\mu V$ in standard RF input conditions. Please select SIF BPFs that group delay of 4.5~MHz $\pm 42~kHz$ is flat as possible. And also its gain band width is wide enough to don't loss the CUE signal that locate at 4.5~MHz $\pm 55~kHz$.
- 3) About the characteristic of tuners, Please take the demodulation linearity to be over 250% to don't reduce the sub carrier when the over-modulation occur in high frequency sound by pre-emphasis is.
- 4) In measuring characteristics of separation, please use the stereo modulator that perform good characteristic on encoder and corrected well.
 - In case of using SIF input, please correct FM modulation band to ± 25 kHz exactly at mono 100% mod pre-emphasis OFF with the 0 carrier method.
 - And, please use LPFs that reduce 30 kHz signal over 20 dB setting between line-outs and AB level meter

■ Application Circuit (continued)

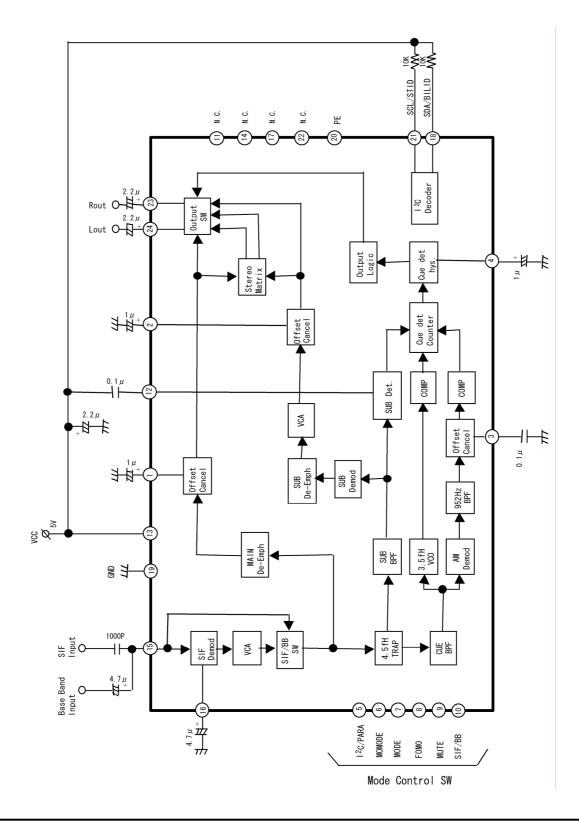
(1) Example of No Adjustments Application Circuits in case of SIF Input



(2) Example of No Adjustments Application Circuits in case of Base Band Input



■ Block Diagram



Panasonic

■ Pin Descriptions

Pin No.	Function			
1	MAIN REF			
2	SUB REF			
3	CUE DET			
4	COMP			
5	I ² C / Parallel SW			
6	MOMODE SW			
7	MODE SW			
8	Force monaural SW			
9	Mute SW			
10	SIF / Base band SW			
11	N. C.			
12	SUB DET			
13	V _{CC}			
14	N. C.			
15	Input			
16	SIF REF			
17	N. C.			
18	SDA / BILID			
19	Ground			
20	PE			
21	SCL / STID			
22	N. C.			
23	Right - channel output			
24	Left - channel output			

■ Absolute Maximum Ratings

No.	Parameter	Symbol	Rating	Unit	Note
1	Storage temperature	T_{stg}	-55 to +125	°C	*1
2	Operating ambient temperature	T_{opr}	-20 to +85	°C	*1
3	Operating ambient atmospheric pressure	P _{opr}	$1.013 \times 10^5 \pm 0.61 \times 10^5$	Pa	
4	Operating constant gravity	$G_{ m opr}$	9 810	m/s ²	
5	Operating shock	S _{opr}	4 900	m/s ²	
6	Supply voltage	V _{CC}	6.0	V	
7	Supply current	I_{CC}	32	mA	
8	Power dissipation	P_{D}	192	mW	$T_a = 85^{\circ}C$

Note) *1 : Ta = 25 °C except storage temperature, and operating ambient temperature.

■ Operating Supply Voltage Range

Operating supply voltage range	V _{CC}	4.5 V to 5.5 V
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